

### **Amendment to the Specification**

**The Paragraph beginning at Page 17, lines 8-14, is to be amended as follows:**

The printhead also includes, with respect to each nozzle 3, side walls 6 on which the nozzle plate is supported, a chamber 7 defined by the walls and the nozzle plate 2, a multi-layer substrate 8 and an inlet passage 9 extending through the multi-layer substrate to the far side (not shown) of the substrate. Referring briefly to Figure 22, the multi-layer substrate 8 comprises a silicon substrate portion 21, drive transistors (not shown) in the region 22, standard CMOS interconnect layers 23 and a passivation layer 24. The drive transistors are electrically connected to heater elements 10 corresponding to the nozzles 3.